



### PCB LAYOUT

所有尺寸公差 ±0.05mm

**NOTES:**

**1. MATERIAL:**

- 1.1 HOUSING: THERMOPLASTIC FLAMMABILITY RATING UL94V-0
- 1.2 CONTACT: COPPER ALLOY T=0.12mm
- 1.3 SHELL: STAINLESS STEEL T=0.15mm

**2. FINISH:**

- 2.1 CONTACT: 3u" Min. Au PLATED ON CONTACT AREA  
G/F PLATING ON SOLDER TAIL AREA
- 2.2 SOLDER: "Ni" NICKEL UNDERPLATING OVERALL

**3. SPECIFICATION:**

- 3.0 FINISH: PLATED UNDER.
- 3.1 CURRENT RATING: 0.5 A MAX.
- 3.2 VOLTAGE: 100 VAC
- 3.3 TEMPERATURE RANGE: -55 °C ~ 85 °C
- 3.4 CONTACT RESISTANCE: 50 MILLIONHM MAX.
- 3.5 DIELECTRIC WITHSTANDING VOLTAGE: 500 VAC r.m.s
- 3.6 INSULATION RESISTANCE: 1000 MEGOHMS MIN

GENERAL TOLERANCE		DWG NO.	JYSA1017-001	APPD:	WNO	Scale	1:1
X ±0.45	X ±.5°	Title	2.00 SIM CARD 6P 短体连接式	CHKD:		UNIT	mm
.X ±0.35	.X ±.2°	DR:		Date	2011/10/31		
XX ±0.25	.XX ±.1°	Part NO.	JYS-SIM200-113				
.XXX ±0.15	.xxx ±0.5°						
SHEET	1/1						

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REV.	EQN. NO.	MODIFY CONTENT	DATE
A		NEW	2011/10/31